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500.38090X00

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicants: T. WATANABE et al.  
Serial No.: 09/462,796  
Filed: January 13, 2000  
For: METHOD FOR PRODUCING A SEMICONDUCTOR DEVICE  
WITH PYRAMIDAL BUMP ELECTRODES BONDED ON PAD  
ELECTRODES ARRANGED ON A SEMICONDCUTOR CHIP  
(As Amended)  
Group: 2813  
Examiner: T. Nguyen

**SUPPLEMENTAL AMENDMENT**

**Mail Stop Amendment**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**April 17, 2007**

Sir:

In further response to the final Office Action dated October 2, 2006, and as a supplement to the Amendment After Final filed March 2, 2007, reconsideration and withdrawal of the outstanding rejections and allowance of the present application are respectfully requested in view of the following amendments and remarks:

**Amendments to the claims** begin on page 2

**Remarks** are included following the amendments.